ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INDUSTRIES® INTERNATIONAL DISTRICTION OF THE STREET	kburn, Illinois. A	ll rights reserved ur utions.	nder both This do level pa	cument rts, the	is a declaration declaration en	n of the substance compasses all low	es within the manufactur wer level materials for w	rer listed it hich the m	tem. Note: if nanufacturer I	the item is an as has engineering	sembly with lower responsibility.
1752-21.1 IPC Web Site for Information or http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on		
Supplier Information											
mpany name* Company unique ID				Unique ID Authority				Response Date*			
onsemi	ni							2024-04-20			
Contact Name	Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	rds Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
thorized Representative* Title - Representative				Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr It	em Number	Mfr Item Name		Ef	ffective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type
NCP4 MN12	BG Secondary Side Syn Driver for High Eff		nchronous Rectificatio	n 20 gies	)24-04-20	MY1		1	10.01	mg	Each
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material	Ferminal Plating / Grid Array Material     Terminal Base Alloy		-STD-020 MSL Rating		Peak Proce	ss Body Tempera	ture Max Time at Peak	Temperat	ure Numbe	er of Reflow Cyc	cles
Matte Tin (Sn) - annealed CU Alloy 1					260	С	30	secon	ds 3		
Comments											
level 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds									
For more information regarding material composition	n please refer to	page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted	
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg
Die Attach	0.24	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.048	mg
			Supplier	Silver (Ag)	7440-22-4		0.192	mg
Lead Frame	3.71	mg	Supplier	Silver (Ag)	7440-22-4		0.0371	mg
			Supplier	Tin (Sn)	7440-31-5		0.0093	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0093	mg
			Supplier	Copper (Cu)	7440-50-8		3.6462	mg
Mold Compound-Black	5.0	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.4	mg
			Supplier	Carbon Black (C)	1333-86-4		0.025	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.325	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.15	mg
Plating	0.29	mg	Supplier	Tin (Sn)	7440-31-5		0.29	mg
Wire Bond - Au	0.67	mg	Supplier	Gold (Au)	7440-57-5		0.67	mg